1717468-3 Product Details

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1717468-3

TE Internal Number: 1717468-3

Active

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Memory Sockets

Always EU RoHS/ELV Compliant (Statement of Compliance)

Product Highlights:

- Socket Type = Memory Card
- Socket Style = SO DIMM
- Gold Flash Contact Plating, Mating Area, Material
- 200 Positions
- DRAM Type = Double Data Rate (DDR)

View all Features

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Documentation & Additional Information

Product Drawings:
- DDR1 & DDR2 SODIMM SOCKET 0.6mm PITCH 200POS 6.5 HEI... (PDF, English)

Catalog Pages/Data Sheets:
- None Available

Product Specifications:
- DDR S.O.DIMM Socket 200 Positions (PDF, English)

Application Specifications:
- None Available

Instruction Sheets:
- None Available

CAD Files: (CAD Format & Compression Information)
- 2D Drawing (DXF, Version D)
- 3D Model (IGES, Version D)
- 3D Model (STEP, Version D)

List all Documents

Additional Information:
- Product Line Information

Related Products:
- Tooling

Product Features (Please use the Product Drawing for all design activity)

Product Type Features:
- Socket Style = SO DIMM
- DRAM Type = Double Data Rate (DDR)
- PCB Mount Style = Surface Mount
- Module Orientation = Right Angle
- Profile = Standard

Mechanical Attachment:
- Keying = Standard

Electrical Characteristics:
- DRAM Voltage = 2.5 V

Termination Related Features:
- Solder Tail Contact Plating = Gold Flash

Body Related Features:
- Socket Type = Memory Card
- Number of Positions = 200
- Row-to-Row Spacing (mm [in]) = 6.20 [0.244]
- Centerline (mm [in]) = 0.60 [0.024]
- Number of Rows = Dual
- Ejector Type = Locking
- Ejector Location = Both Ends
- Number of Keys = 1
- Latch Material = Stainless Steel
- Boss = With
- Mount Type = Printed Circuit Board

Contact Related Features:
- Contact Plating, Mating Area, Material = Gold Flash
- Contact Base Material = Copper Alloy

Housing Related Features:
- Housing Material = High Temperature Thermoplastic
- Housing Color = Black
- UL Flammability Rating = UL 94V-0

Configuration Related Features:
- Stack Height (mm [in]) = 6.50 [0.256]
- Insertion Style = Cam-In
- Center Key (mm [in]) = None

Industry Standards:
- RoHS/ELV Compliance = RoHS compliant, ELV compliant
- Lead Free Solder Processes = Reflow solder capable to 245°C, Reflow solder capable to 260°C
- RoHS/ELV Compliance History = Always was RoHS compliant

Operation/Application:
- Application Type = DDR SDRAM

Packaging Related Features:
- Packaging Method = Semi-Hard Tray Assembly
- Packaging Quantity = 20 Pieces/Tray

Other:
- Brand = AMP

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